20V N-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V_{(BR)DSS}=20V$; $R_{DS(ON)}=0.02\Omega$ $I_{D}=7.6A$

DESCRIPTION

This new generation of TRENCH MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

FEATURES

- Low on-resistance
- · Fast switching speed
- · Low threshold
- Low gate drive
- Low profile SOIC package

APPLICATIONS

- DC DC Converters
- Power Management Functions
- Disconnect switches
- Motor control

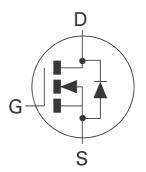
ORDERING INFORMATION

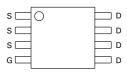
DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZXMN2A02X8TA	7"	12mm	1000 units
ZXMN2A02X8TC	13"	12mm	4000 units

DEVICE MARKING

 ZXMN 2A02







Top View



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DSS}	20	V
Gate Source Voltage	V _{GS}	±12	V
Continuous Drain Current $V_{GS}=10V; T_A=25^{\circ}C$ (b) $V_{GS}=10V; T_A=70^{\circ}C$ (b) $V_{GS}=10V; T_A=25^{\circ}C$ (a)	I _D	7.6 6.1 6	А
Pulsed Drain Current (c)	I _{DM}	27	А
Continuous Source Current (Body Diode) (b)	Is	3.1	А
Pulsed Source Current (Body Diode) (c)	I _{SM}	27	А
Power Dissipation at T _A =25°C (a) Linear Derating Factor	P _D	1.1 8.8	W mW/°C
Power Dissipation at T _A =25°C (b) Linear Derating Factor	P _D	1.8 14.4	W mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +150	°C

THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	R _{eJA}	113	°C/W
Junction to Ambient (b)	R _{eJA}	70	°C/W

NOTES

- (a) For a device surface mounted on $25mm \times 25mm FR4$ PCB with high coverage of single sided 1oz copper, in still air conditions
- (b) For a device surface mounted on FR4 PCB measured at t≤10 secs.
- (c) Repetitive rating 25mm x 25mm FR4 PCB, D = 0.05, pulse width $10\mu s$ pulse width limited by maximum junction temperature.



ELECTRICAL CHARACTERISTICS (at $T_A = 25^{\circ}C$ unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.	
STATIC			•	'			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	20			V	$I_{D}=250\mu A, V_{GS}=0V$	
Zero Gate Voltage Drain Current	I _{DSS}			1	μΑ	V _{DS} =20V, V _{GS} =0V	
Gate-Body Leakage	I _{GSS}			100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
Gate-Source Threshold Voltage	V _{GS(th)}	0.7			V	$I_{D} = 250 \mu A, V_{DS} = V_{GS}$	
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.02 0.04	ΩΩ	V _{GS} =4.5V, I _D =11A V _{GS} =2.5V, I _D =8.4A	
Forward Transconductance (1)(3)	g _{fs}		27		S	V _{DS} =10V,I _D =11A	
DYNAMIC (3)		•	•	•	•		
Input Capacitance	C _{iss}		2050		pF		
Output Capacitance	C _{oss}		300		pF	V _{DS} =15 V, V _{GS} =0V, f=1MHz	
Reverse Transfer Capacitance	C _{rss}		183		pF		
SWITCHING(2) (3)			•	'	•		
Turn-On Delay Time	t _{d(on)}		6.9		ns	$V_{DD} = 10V, I_{D} = 5.5A$ $R_{G} = 6.0\Omega, V_{GS} = 5V$	
Rise Time	t _r		12.2		ns		
Turn-Off Delay Time	t _{d(off)}		32.5		ns		
Fall Time	t _f		11		ns		
Total Gate Charge	Qg		18.6		nC	V _{DS} =10V,V _{GS} =4.5V, I _D =5.5A	
Gate-Source Charge	Q _{gs}		4.1		nC		
Gate-Drain Charge	Q_{gd}		5.1		nC		
SOURCE-DRAIN DIODE	•		•	<u>'</u>	•		
Diode Forward Voltage (1)	V _{SD}		0.8	0.95	V	T _J =25°C, I _S =11A, V _{GS} =0V	
Reverse Recovery Time (3)	t _{rr}		19.3		ns	T _J =25°C, I _F =5.5A, di/dt= 100A/μs	
Reverse Recovery Charge (3)	O _{rr}		9.1		nC		

NOTES

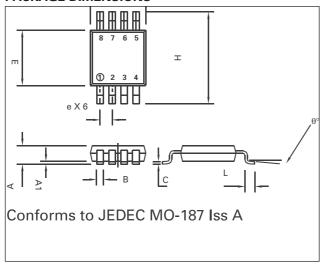


⁽¹⁾ Measured under pulsed conditions. Width=300 $\mu s.$ Duty cycle $\leq~2\%$.

⁽²⁾ Switching characteristics are independent of operating junction temperature.

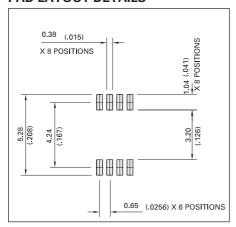
⁽³⁾ For design aid only, not subject to production testing.

PACKAGE DIMENSIONS



DIM	Millimetres		Inches	
	MIN	MAX	MIN	MAX
А		1.10		0.043
A1	0.05	0.15	0.002	0.006
В	0.25	0.40	0.010	0.016
С	0.13	0.23	0.005	0.009
D	2.90	3.10	0.114	0.122
е	0.65	BSC	0.0256	BSC
Е	2.90	3.10	0.114	0.122
Н	4.90	BSC	0.193	BSC
L	0.40	0.70	0.016	0.028
θ°	0°	6°	0°	6°

PAD LAYOUT DETAILS



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